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BGO827; BGO827/FC0; BGO827/SC0

870 MHz optical receivers

Rev. 5 — 29 September 2010

Product data sheet

1. Product profile

1.1 General description

High dynamic range optical receiver amplifier modules in a standard SOT115 package where the non-jacketed fiber has either no connector or has an FC/APC or SC/APC connector.

The amplifier supply voltage pin and the photodiode bias voltage pin both connect to 24 V (DC).

The modules have a mono mode optical input suitable for 1290 nm to 1600 nm wavelengths, a terminal to monitor the photodiode current and an electrical output having a characteristic impedance of 75 Ω .

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Excellent linearity
- Low noise
- Excellent flatness
- Standard CATV outline
- Rugged construction
- Gold metallization ensures excellent reliability
- High optical input power range

1.3 Applications

• CATV optical node systems operating in the 40 MHz to 870 MHz frequency range.



870 MHz optical receivers

1.4 Quick reference data

| Table 1. | Quick reference data | | | | | |
|------------------|--------------------------------|------------------------|-----|-----|-----|--------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| f | frequency range | | 40 | - | 870 | MHz |
| S ₂₂ | output return losses | f = 40 MHz to 870 MHz | 11 | - | - | dB |
| | optical input return losses | | 45 | - | - | dB |
| d ₂ | second order distortion | f = 854.5 MHz | - | - | -57 | dB |
| F | equivalent noise input | f = 40 MHz to 870 MHz | - | - | 8.5 | pA/√Hz |
| I _{tot} | total current consumption (DC) | V _B = 24 V | 175 | - | 205 | mA |

2. Pinning information

| Table 2. | Pinning | | |
|----------|--------------------------|--------------------|----------------|
| Pin | Description | Simplified outline | Graphic symbol |
| BGO827 | (SOT115T) | | |
| 1 | monitor current | | |
| 2, 3 | common | | |
| 4 | $+V_B$ of the photodiode | | |
| 5 | $+V_B$ of the amplifier | | ╼╡╪┻╵ |
| 7, 8 | common | | 1 2, 3, 7, 8 |
| 9 | output | | sym098 |
| BG0827/ | FC0 (SOT115X) | | |
| 1 | monitor current | | |
| 2, 3 | common | | |
| 4 | $+V_B$ of the photodiode | | |
| 5 | $+V_B$ of the amplifier | | ✐╡╪┻╵ |
| 7, 8 | common | | 1 2, 3, 7, 8 |
| 9 | output | | sym098 |
| BG0827/ | SC0 (SOT115Y) | | |
| 1 | monitor current | | _ |
| 2, 3 | common | | |
| 4 | $+V_B$ of the photodiode | | |
| 5 | $+V_B$ of the amplifier | | ╼╡╪┻╵ |
| 7, 8 | common | | 1 2, 3, 7, 8 |
| 9 | output | | sym098 |

3. Ordering information

| Type number | Package | | | | | | | |
|-------------|---------|---|---------|--|--|--|--|--|
| | Name | Description | Version | | | | | |
| BGO827 | - | rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input; 8 gold-plated in-line leads | SOT115T | | | | | |
| BGO827/FC0 | - | rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads | SOT115X | | | | | |
| BGO827/SC0 | - | rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads | SOT115Y | | | | | |

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------------|--|-----|-----|------|
| f | frequency range | | 40 | 870 | MHz |
| T _{stg} | storage temperature | | -40 | +85 | °C |
| T _{mb} | mounting base temperature | | -20 | +85 | °C |
| P _{in} | optical input power | continuous | - | 5 | mW |
| ESD | ESD sensitivity | human body model; R = 1.5 k Ω ; C = 100 pF | 500 | - | V |

5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 870 MHz; $V_B = 24 V$; $T_{mb} = 30 \circ C$; $Z_L = 75 \Omega$.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|---|--|-----|-------|-----|------|
| S | responsivity | | | | | |
| | BGO827 | $\lambda = 1300 \text{ nm}$ | 800 | - | - | V/W |
| | BGO827/FC0; BGO827/SC0 | | 750 | - | - | V/W |
| ΔS | responsivity difference | responsivity at T _{mb} = 85 °C – responsivity at T _{mb} = 30 °C; f = 870 MHz | - | -50 | - | V/W |
| FL | flatness straight line (peak to valley) | f = 40 MHz to 870 MHz | - | - | 1 | dB |
| SL | slope straight line | f = 40 MHz to 870 MHz | 0 | - | 2 | dB |
| ∆SL | slope difference | slope at T_{mb} = 85 °C – slope at T_{mb} = 30 °C | - | -0.35 | - | dB |
| \$ ₂₂ | output return losses | f = 40 MHz to 870 MHz | 11 | - | - | dB |
| | optical input return losses | | 45 | - | - | dB |

870 MHz optical receivers

| Symbol | Parameter | Conditions | | Min | Тур | Мах | Unit |
|-------------------|------------------------------------|---|---------------|------|------|------|-------|
| d ₂ | second order distortion | f _m = 446.5 MHz | [1][2] | - | - | -68 | dB |
| | | f _m = 746.5 MHz | <u>[1][3]</u> | - | - | -63 | dB |
| | | f _m = 854.5 MHz | <u>[1][4]</u> | - | - | -57 | dB |
| ∆d2 | second order distortion difference | d_2 at T_{mb} = 85 °C – d_2 at T_{mb} = 30 °C | | - | 2.5 | - | dB |
| | | d_2 at $T_{mb} = -20 \text{ °C} - d_2$ at $T_{mb} = 30 \text{ °C}$ | | - | -1.5 | - | dB |
| d ₃ | third order distortion | f _m = 853.25 MHz | [5][6] | - | - | -73 | dB |
| $\Delta d3$ | third order distortion difference | d_3 at T_{mb} = 85 °C – d_3 at T_{mb} = 30 °C | | - | 1 | - | dB |
| | | d_3 at $T_{mb} = -20 \text{ °C} - d_3$ at $T_{mb} = 30 \text{ °C}$ | | - | -1 | - | dB |
| F | equivalent noise input | f = 40 MHz to 450 MHz | | - | - | 7 | pA/√H |
| | | f = 450 MHz to 750 MHz | | - | - | 8 | pA/√H |
| | | f = 750 MHz to 870 MHz | | - | - | 8.5 | pA/√H |
| s _λ | spectral sensitivity | λ = 1310 ±20 nm | | 0.85 | - | - | A/W |
| | | $\lambda = 1550 \pm 20 \text{ nm}$ | | 0.9 | - | - | A/W |
| λ | optical wavelength | | | 1290 | - | 1600 | nm |
| L | length of optical fiber | SM type; 9/125 μm | | | | | |
| | BGO827 | | | 1 | - | - | m |
| | BGO827/FC0; BGO827/SC0 | | | 746 | - | 861 | mm |
| I _{tot} | total current consumption (DC) | | | 175 | - | 205 | mA |
| I _{bias} | diode bias current at pin 4 (DC) | | | - | - | 25 | mA |

Table 5. Characteristics ... continued

[1] Two laser test; each laser with a modulation index of 40 %; P_{opt} = 1 mW (total)

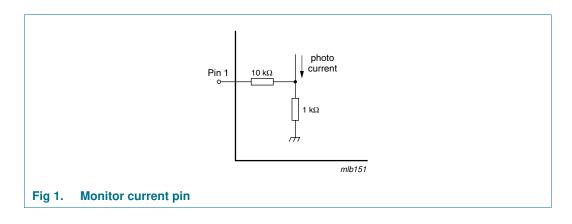
[2] $f_m = 446.5 \text{ MHz}; f_p = 97.25 \text{ MHz}; f_q = 349.25 \text{ MHz}$

 $[3] \quad f_m = 746.5 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 613.25 \text{ MHz}$

[4] $f_m = 854.5 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 721.25 \text{ MHz}$

[5] Three laser test; each laser with a modulation index of 60 %; $P_{opt} = 1 \text{ mW}$ (total)

[6] $f_m = 853.25 \text{ MHz}; f_p = 133.25 \text{ MHz}; f_q = 265.25 \text{ MHz}; f_r = 721.25 \text{ MHz}$

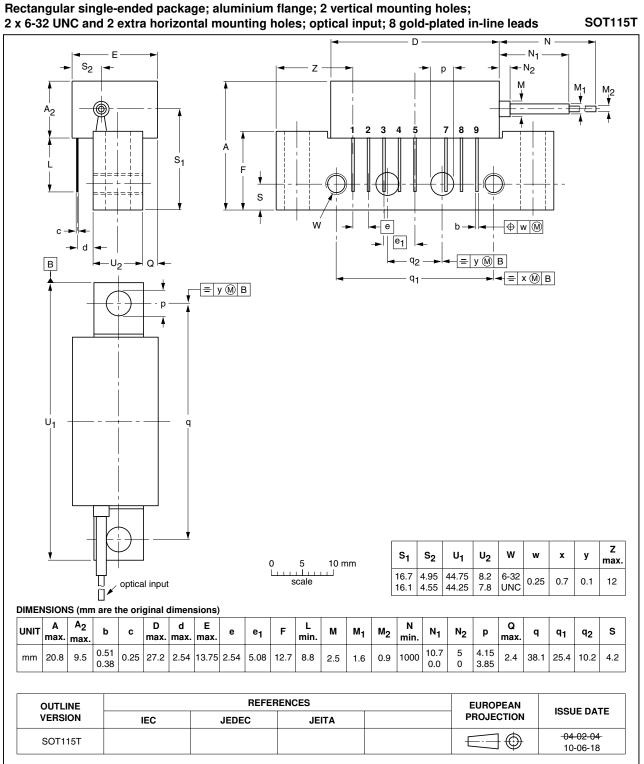


NXP Semiconductors

BG0827; BG0827/FC0/SC0

870 MHz optical receivers

Package outline 6.



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BGO827 FC0 SC0

Package outline SOT115T Fig 2.

870 MHz optical receivers

SOT115X

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

Е D N₁ s₂ Ζ р N_2 М M₁ M_2 ¥ A₂ 2 7 8 9 3 4 S₁ Т s 4 с 🗕 w 0 w 🕅 е h 🗕 d e₁ Q Uo В - = y M B q2 = y 🕅 B ◄ = x (M) B q1 p Ν R U q 25 mm Scale connector 10 mm z 5 0 s₁ s₂ U₁ s w U2 w х у тŤт max Т scale 16.7 4.95 44.75 8.2 6-32 4.2 Ũ 0.25 0.7 0.1 12 16.1 4.55 44.25 7.8 UNC DIMENSIONS (mm are the original dimensions) D Е R Α Α2 d L Q M₂ UNIT F M₁ b с Μ Ν е e₁ N₁ N_2 р q q1 q2 max. max max. max. max min. max min. 0.51 861 10.7 5 4.15 20.8 9.5 0.25 27.2 2.54 13.75 2.54 5.08 8.8 2.5 0.9 2.4 38.1 25.4 10.2 35 mm 12.7 1.6 0.38 746 0.0 0 3.85 REFERENCES EUROPEAN OUTLINE ISSUE DATE VERSION IEC JEDEC PROJECTION JEITA 04-02-04 \bigcirc SOT115X ----10-06-18

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Product data sheet

BGO827_FC0_SC0

Fig 3. Package outline SOT115X

870 MHz optical receivers

SOT115Y

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

Е D N₁ s₂ Ζ р N_2 М M₁ M₂ ¥ A₂ 2 7 8 9 3 4 S₁ Т s 4 с 🗕 w 0 w е h → d e₁ U_2 Q В - = y M B q2 = y 🕅 B q1 p Ν R U q 0 25 mm Scale connector z 10 mm 5 0 s s₁ S_2 U1 U2 w w x у max τŤ. L Π scale 6-32 UNC 16.7 4.95 44.75 8.2 4.2 0.25 0.7 0.1 12 Ũ 7.8 4.55 44.25 16.1 DIMENSIONS (mm are the original dimensions) D Е R Α Α2 d L Q M₂ UNIT F М₁ N₁ b с М Ν N_2 е e₁ р q q1 q2 max. max max. max. max min. max min. 0.51 861 10.7 5 4.15 20.8 9.5 0.25 27.2 2.54 13.75 2.54 5.08 8.8 2.5 0.9 2.4 38.1 25.4 10.2 35 mm 12.7 1.6 0.38 746 0.0 0 3.85 REFERENCES EUROPEAN OUTLINE ISSUE DATE VERSION IEC JEDEC PROJECTION JEITA 04-02-05 \odot SOT115Y **—** 10-06-18

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Product data sheet

BGO827 FC0 SC0

Fig 4. Package outline SOT115Y

7. Handling information

Fiberglass optical coupling: maximum tensile strength = 5 N; minimum bending radius = 35 mm.

8. Revision history

| Table 6. Revision hist | ory | | | |
|--|---------------------------------|---|---------------------|-------------------------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| BGO827_FC0_SC0 v.5 | 20100929 | Product data sheet | - | BGO827_FC0_SC0 v.4 |
| Modifications: | | of this data sheet has been re f NXP Semiconductors. | edesigned to comply | with the new identity |
| | Legal texts | have been adapted to the ne | w company name wh | nere appropriate. |
| | Package ou | tline and simplified outline dr | awings have been up | odated to the latest version. |
| BGO827_FC0_SC0 v.4 (9397 750 14436) | 20050329 | Product data sheet | - | BGO827_FC0_SC0 v.3 |
| BGO827_FC0_SC0 v.3 (9397 750 13061) | 20040407 | Product specification | - | BGO827_FC0_SC0 v.2 |
| BGO827_FC0_SC0 v.2 (9397 750 10522) | 20021210 | Product specification | - | BGO827_FC0_SC0 v.1 |
| BGO827_FC0_SC0 v.1 (9397 750 09934) | 20020627 | Product specification | - | - |

9. Legal information

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| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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11. Contents

| 1 | Product profile 1 |
|-----|-------------------------|
| 1.1 | General description 1 |
| 1.2 | Features and benefits 1 |
| 1.3 | Applications 1 |
| 1.4 | Quick reference data 2 |
| 2 | Pinning information 2 |
| 3 | Ordering information 3 |
| 4 | Limiting values 3 |
| 5 | Characteristics 3 |
| 6 | Package outline 5 |
| 7 | Handling information8 |
| 8 | Revision history 8 |
| 9 | Legal information 9 |
| 9.1 | Data sheet status 9 |
| 9.2 | Definitions9 |
| 9.3 | Disclaimers 9 |
| 9.4 | Trademarks 10 |
| 10 | Contact information 10 |
| 11 | Contents 11 |

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